



ORIENT

Photocoupler

Product Data Sheet

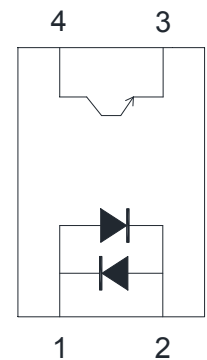
P/N: Photocoupler
Customer:
Mfg P/N: OR-354
Date:

SHENZHEN ORIENT COMPONENTS CO.,LTD.

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1. Features

- Current transfer ratio(CTR : MIN. 20% at $I_F = \pm 1\text{mA}$, $V_{CE} = 5\text{V}$, $T_a = 25^\circ\text{C}$)
- High input -output isolation voltage ($V_{ISO} = 3,750\text{Vrms}$)
- High collector-emitter voltage ($V_{CEO} = 35\text{V}$)
- SOP-4 package
- -55°C to 115°C
- RoHS Compliance



1 Anode 2 Cathode
3 Emitter 4 Collector

2. Instructions

- The OR-354 series device consists of two infrared emitting diode, connected in inverse parallel, optically coupled to a phototransistor detector. They are encapsulated in a 4 pin SOP encapsulation.
- Pin pitch of OR-354 is 2.54mm

3. Application Range

- Hybrid substrates that require high density mounting.
- Programmable controllers
- System appliance, measuring instruments

4. Max Absolute rated Value (Normal Temperature=25°C)

Parameter		Symbol	Rated Value	Unit
Input	Forward Current	I_F	± 50	mA
	Junction Temperature	T_J	125	$^\circ\text{C}$
	Consume Power	P	70	mW
Output	Collector and emitter Voltage	V_{CEO}	35	V
	Emitter and collector Voltage	V_{ECO}	6	
	Collector Current	I_C	50	mA
	Consume Power	P_C	150	mW
	Junction Voltage	T_J	125	$^\circ\text{C}$
Total Consume Power		P_{tot}	170	mW
*1 Insulation Voltage		V_{iso}	3750	Vrms

Working Temperature	Topr	-55 to + 115	°C
Deposit Temperature	T _{stg}	-55 to + 150	
*2 Soldering Temperature	T _{sol}	260	

- *1. AC Test, 1 minute, humidity = 40~60%
 Insulation test method as below:
 (1) Short circuit both terminals of photocoupler.
 (2) No Current when testing insulation voltage.
 (3) Adding sine wave voltage when testing.

- *2. soldering time is 10 seconds.

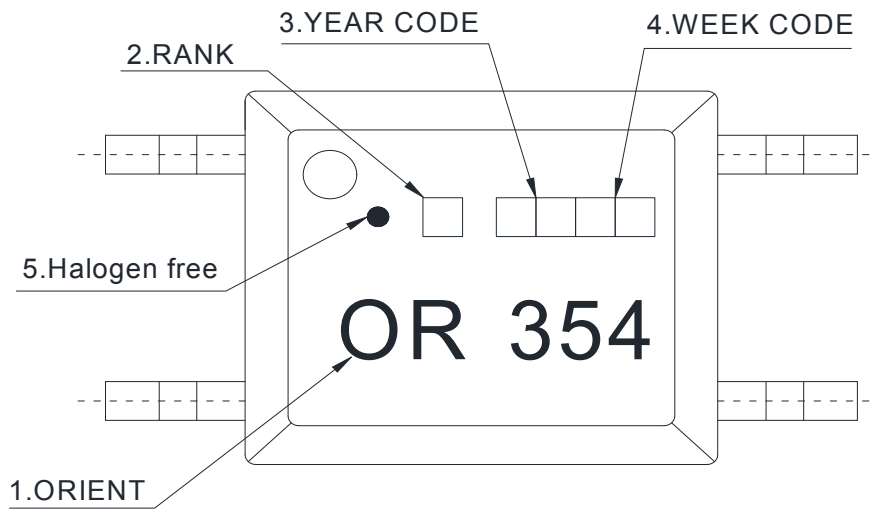
5. Opto-electronic Characteristics

Parameter		Symbol	Condition	Min	Typ.*	Max	Unit
Input	Forward Current	V _F	I _F =±20mA	---	1.2	1.4	V
	Collector capacitance	C _t	V=0, f=1KHz	---	30	250	pF
Output	Collector to emitter Current	I _{CEO}	V _{CE} =20V, I _F =0mA	---	---	100	nA
	Collector and Emitter attenuation Voltage	BV _{CEO}	I _C =0.1mA I _F =0mA	35	---	---	V
	Emitter and Collector attenuation Voltage	BV _{ECO}	I _E =10μA I _F =0mA	6	---	---	V
	Collector and Emitter Saturation Voltage	V _{CE(sat)}	I _F =±20mA I _C = 1mA	---	---	0.2	V
	Insulation Impedance	R _{iso}	DC500V 40~60%R.H.	5×10 ¹⁰	1×10 ¹¹	---	Ω
	Floating Capacitance	C _f	V=0, f=1MHz	---	0.6	1	pF
	Response Time	t _r	V _{CC} =2V, I _C =2mA R _L =100Ω	---	4	18	μs
Descend Time	t _f	---		3	18	μs	

6. Rank table of current transfer ratio CTR

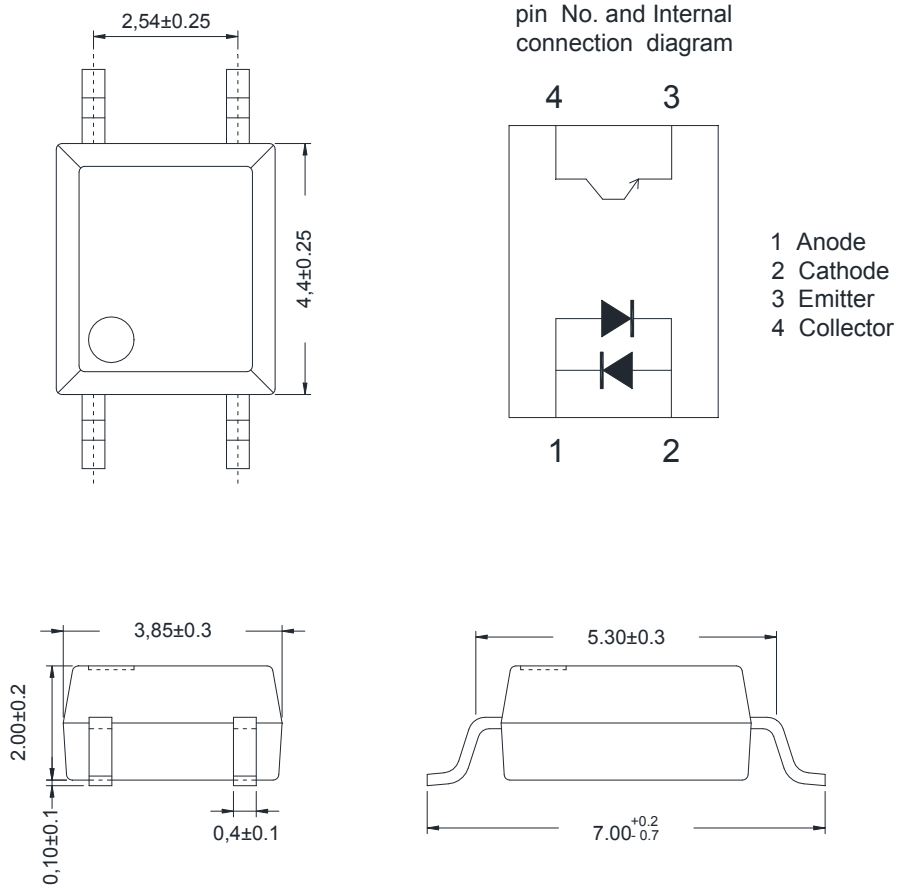
CTR Rank	Min.	Max.	Condition
A	50	150	$I_F = \pm 1\text{mA}, V_{CE} = 5\text{V}, T_a = 25^\circ\text{C}$
B	80	400	
B2	100	400	
C	200	400	
No mark	20	400	

7. Naming Rule

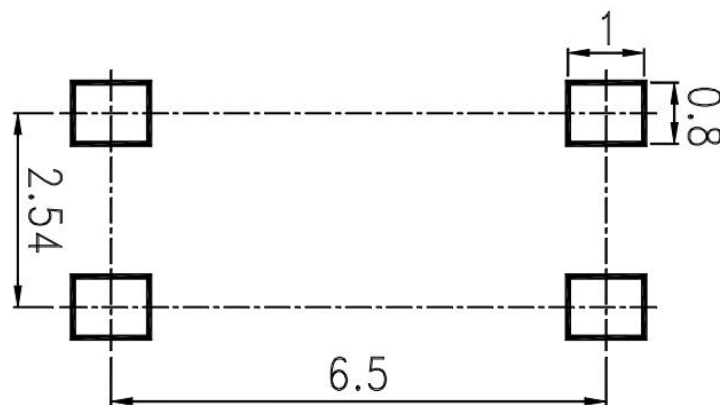


1. ORIENT
2. Rank shall be or shall not be marked.
3. Year Code, Example : 2010 = 10
4. Work Week Ranging from '01' to '53'
5. "●" indicates halogen free option.

8. Outer Dimension



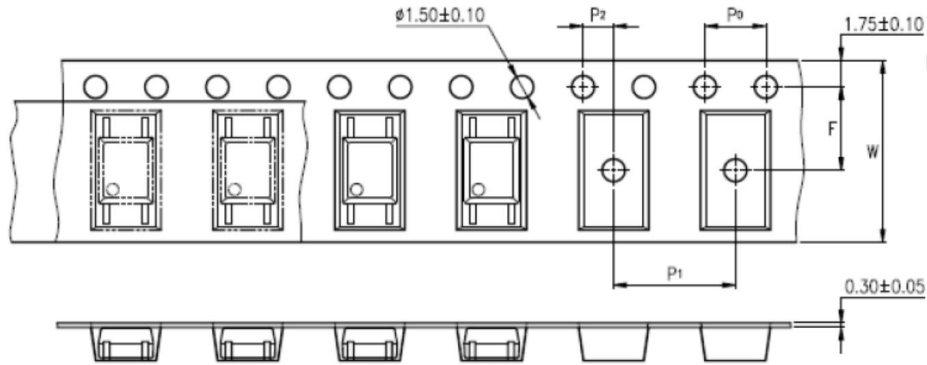
9. Recommended Foot Print Patterns (Mount Pad)



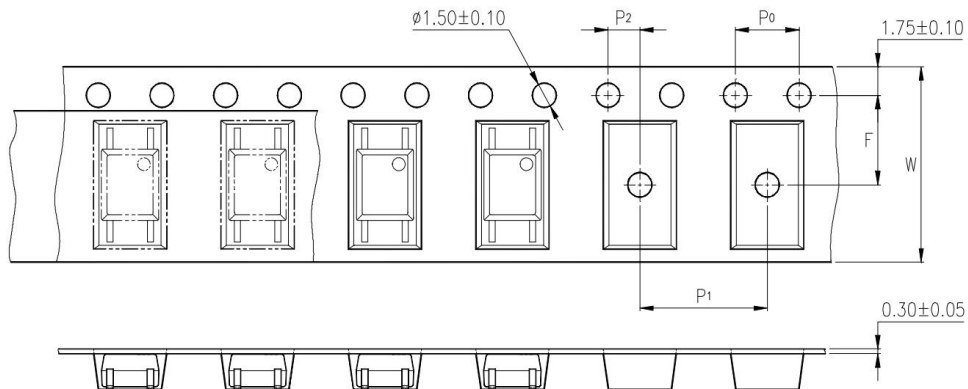
unit: mm

10. Taping Dimensions

(1) OR-354-TP



(2) OR-354-TP1



Description	Symbol	Dimension in mm(inch)
Tape wide	W	12±0.3 (0.472)
Pitch of sprocket holes	P0	4±0.1 (0.157)
Distance of compartment	F	5.5±0.1 (0.217)
	P2	2±0.1 (0.079)
Distance of compartment to compartment	P1	8±0.1 (0.315)

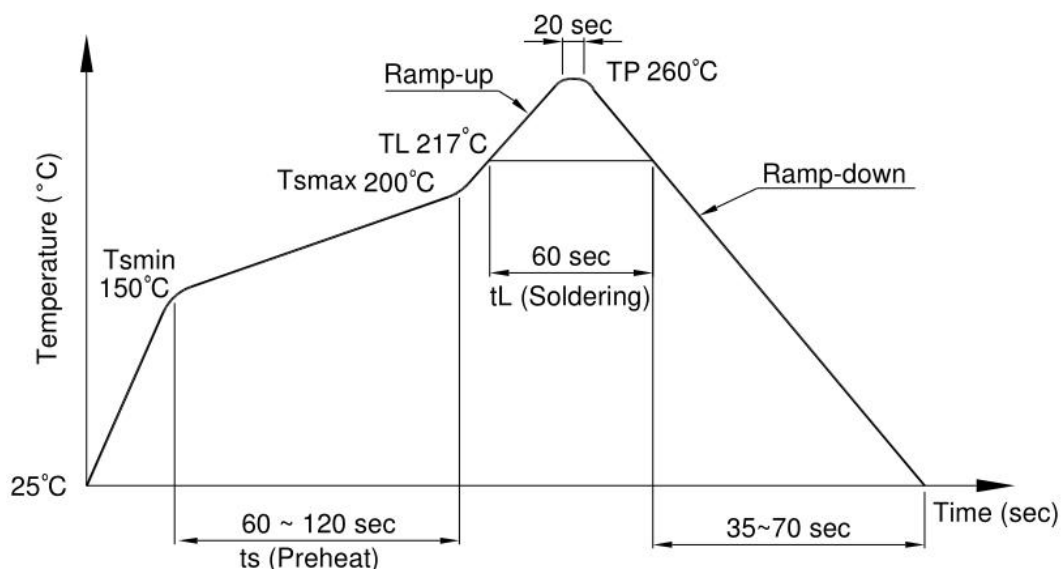
Package Type	OR-354 series
Quantities(pcs)	3000

11. Temperature Profile Of Soldering

(1) IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

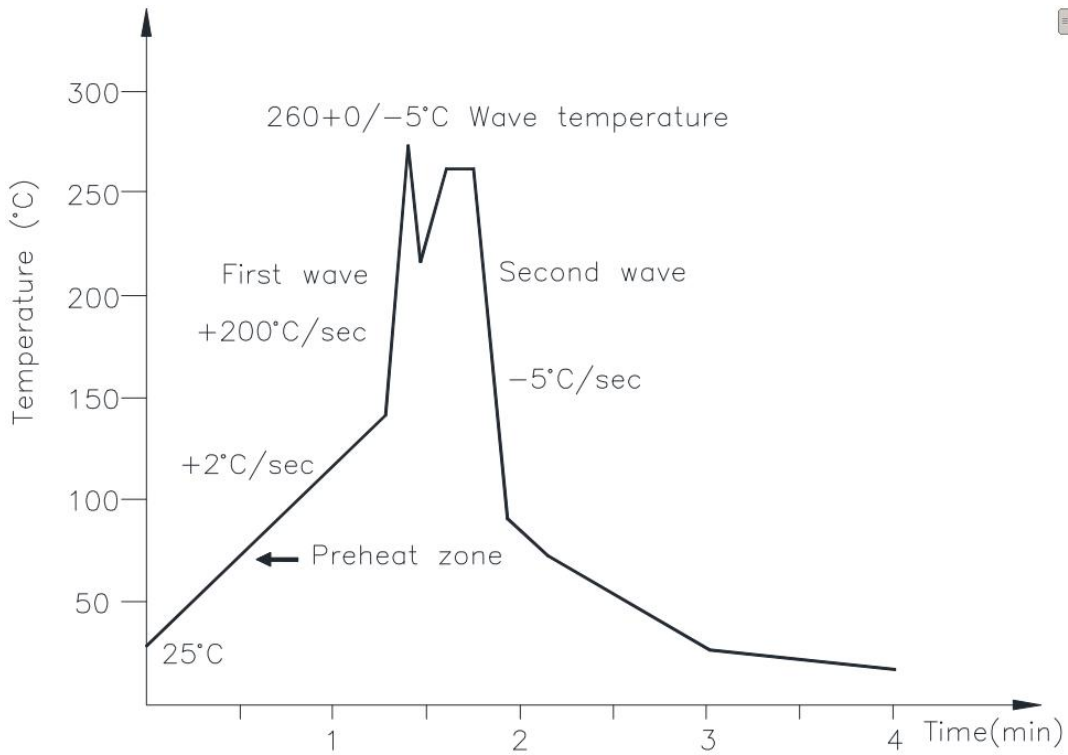
Profile item	Conditions
Preheat	
- Temperature Min (T Smin)	150°C
- Temperature Max (T Smax)	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (TL)	217°C
- Time (t L)	60 sec
Peak Temperature	260°C
Ramp-up rate	3°C / sec max.
3°C / sec max.	3~6°C / sec



(2) Wave soldering (JEDEC22A111 compliant)

One time soldering is recommended within the condition of temperature.

Temperature	260+0/-5°C
Time	10 sec
Preheat temperature	5 to 140°C
Preheat time	30 to 80 sec



(3) Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature	380+0/-5°C
Time	3 sec max

12. Characteristics Curve

Fig.1 Forward Current vs. Ambient Temperature

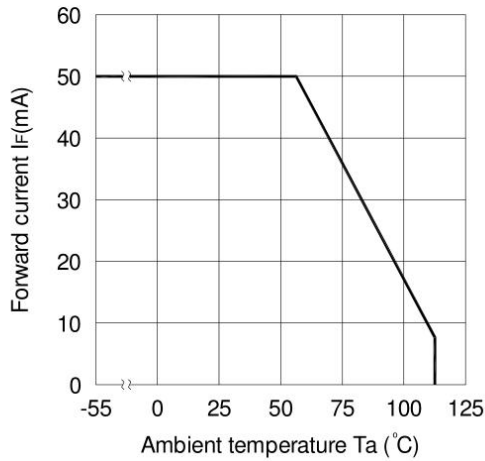


Fig.2 Collector Power Dissipation vs. Ambient Temperature

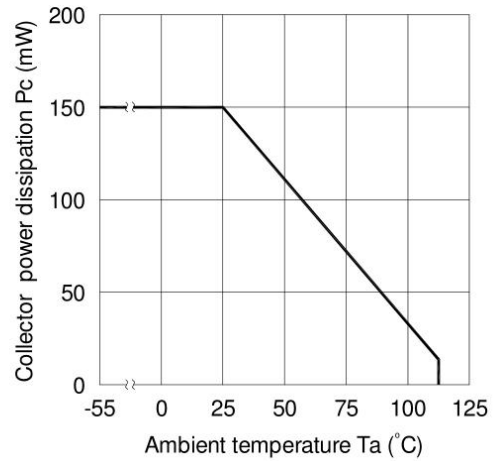


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

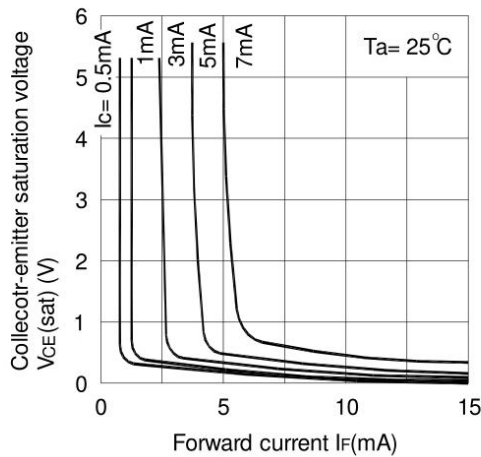


Fig.4 Forward Current vs. Forward Voltage

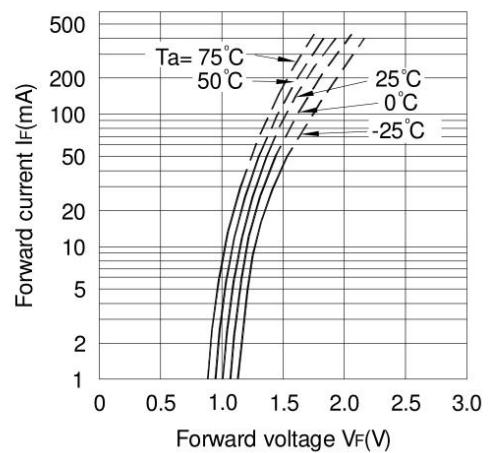


Fig.5 Current Transfer Ratio vs. Forward Current

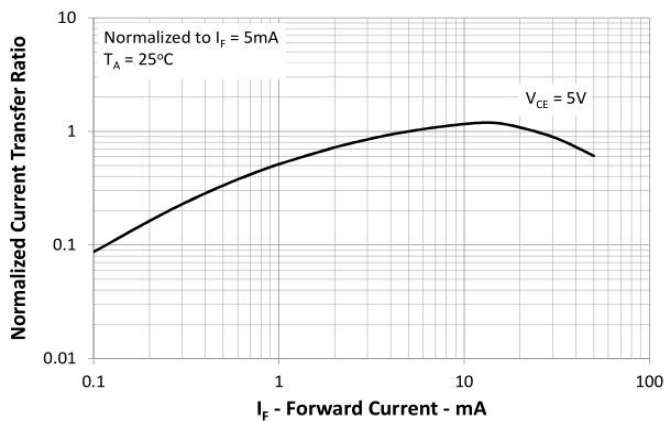


Fig.6 Collector Current vs. Collector-emitter Voltage

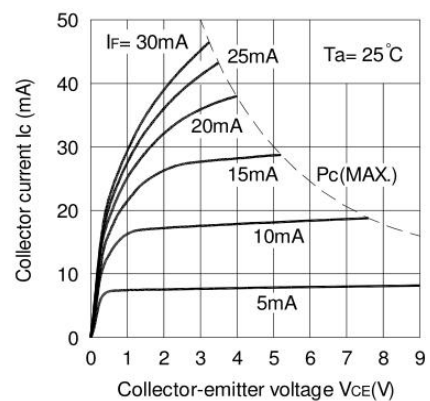


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

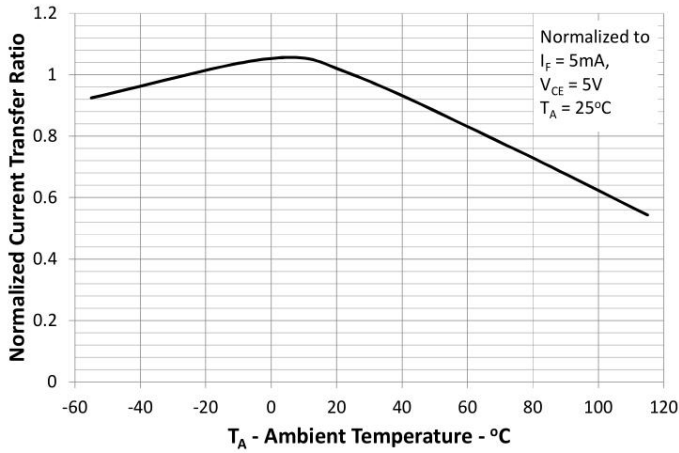


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

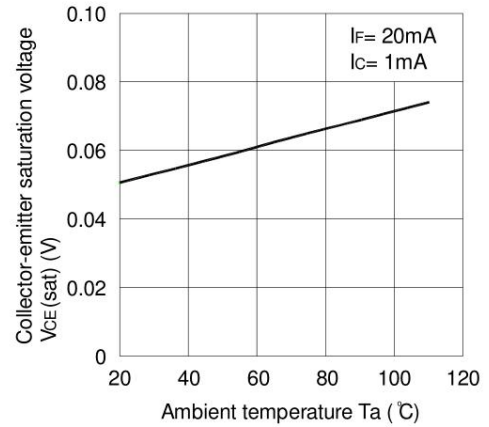


Fig.9 Collector Dark Current vs. Ambient Temperature

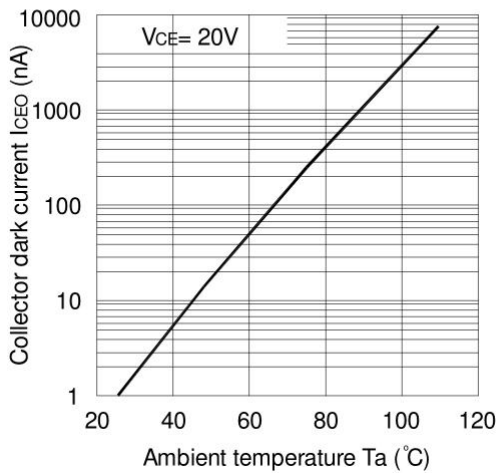


Fig.10 Response Time vs. Load Resistance

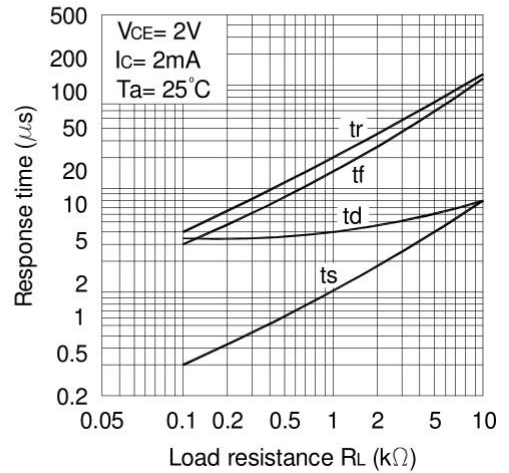
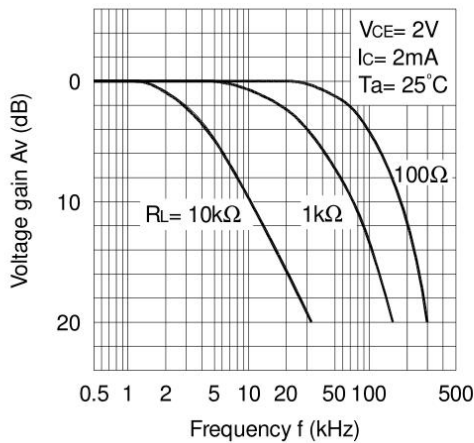
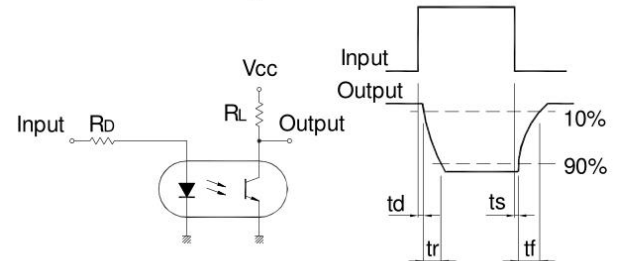


Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response

